

FEATURES 特征

- High temperature resistance & low coefficient of thermal expansion.
耐高温，热膨胀系数低
- Gold-plated terminals with excellent oxidation resistance.
镀金端子，抗氧化
- Operating Temp : -40°C~+125°C(Including self heating)
工作温度范围:-40~+125°C(包括自身温度上升)



APPLICATIONS 用途

- handheld devices and other portable products...
应用于手持设备及其他便携式产品等领域

PART NUMBERING 产品型号

APDO	1608	C	-	103	M	L	C
①	②	③		④	⑤	⑥	⑦

① Series Name	
APDO	Wire Wound SMD Power Inductors

② External Dimensions	
1608	6.6x4.45x2.92mm

③ Characteristic type	
	C

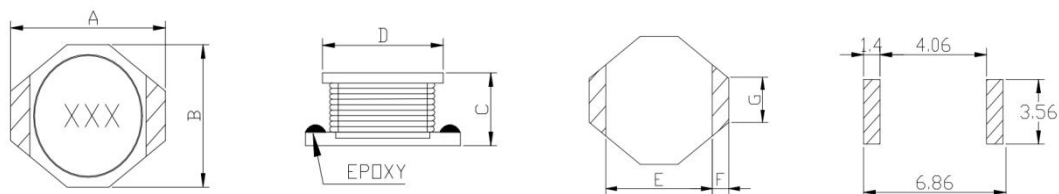
④ Inductance	
Code (example)	Nominal inductance [μH]
103	10 μH
104	100 μH

⑤ Inductance tolerance	
Code (example)	Inductance tolerance
M	±20%

⑥ Termination code	
L	RoHS compliant

⑦ Packaging	
C	Tape & Reel

DIMENSIONS & RECOMMENDED LAND PATTERN 尺寸及推荐焊盘



RECOMMENDED LAND PATTERN

Unit: mm

Dimensions							
Series	A Max.	B Max.	C Max.	D Typ.	E Typ.	F Typ.	G Typ.
APDO1608C	6.60	4.45	2.92	3.9	4.32	1.02	1.27

ELECTRICAL CHARACTERISTICS 特性规格表

Part Number	Inductance @100KHz/0.1V ($\mu\text{H} \pm 20\%$)	DC resistance (Ω)		Temperature Rise Current (A)	Saturation Current (A)
		Typ.	Max.	Typ.	Typ.
APDO1608C-102MLC	1	0.022	0.05	2.9	2.9
APDO1608C-152MLC	1.5	0.021	0.06	2.6	2.8
APDO1608C-222MLC	2.2	0.028	0.07	2.3	2.4
APDO1608C-272MLC	2.7	0.044	0.08	2.1	2.1
APDO1608C-332MLC	3.3	0.051	0.08	2	2
APDO1608C-472MLC	4.7	0.057	0.09	1.5	1.5
APDO1608C-682MLC	6.8	0.07	0.13	1.2	1.4
APDO1608C-822MLC	8.2	0.08	0.16	1.15	1.3
APDO1608C-103MLC	10	0.099	0.16	1.1	1.1
APDO1608C-153MLC	15	0.153	0.23	0.9	1
APDO1608C-223MLC	22	0.213	0.37	0.7	0.8
APDO1608C-333MLC	33	0.333	0.51	0.58	0.6
APDO1608C-473MLC	47	0.471	0.64	0.5	0.5
APDO1608C-683MLC	68	0.659	0.86	0.4	0.4
APDO1608C-104MLC	100	0.975	1.27	0.31	0.3
APDO1608C-154MLC	150	1.473	2	0.27	0.25
APDO1608C-224MLC	220	2.261	3.11	0.22	0.2
APDO1608C-334MLC	330	3.54	3.8	0.18	0.16
APDO1608C-474MLC	470	4.808	5.06	0.16	0.15
APDO1608C-684MLC	680	6.278	9.2	0.14	0.12
APDO1608C-105MLC	1000	10.035	13.8	0.1	0.07
APDO1608C-155MLC	1500	24.3	27.6	0.06	0.04
APDO1608C-225MLC	2200	29	34.5	0.05	0.04

- All test DCR is referred to $25^\circ\text{C} \pm 5^\circ\text{C}$ ambient.
- Irms:DC current (A)that will cause an approximate ΔT of 40°C (Typical) .
- Isat:DC current (A) that will cause L_o to drop approximately 10%(maxical) .

- Operating temperature range -40°C to $+125^{\circ}\text{C}$.
- Inductance tolerance $\pm 20\%$, 100KHz and 0.1Vrms.
- The part temperature (ambient + temp rise) should not exceed 125°C under worst case operating conditions.
- Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provision all affect.
- the part temperature. Part temperature should be verified in the end application.
- The rated current as listed is either the saturation current or the heating current depending on which value is lower.

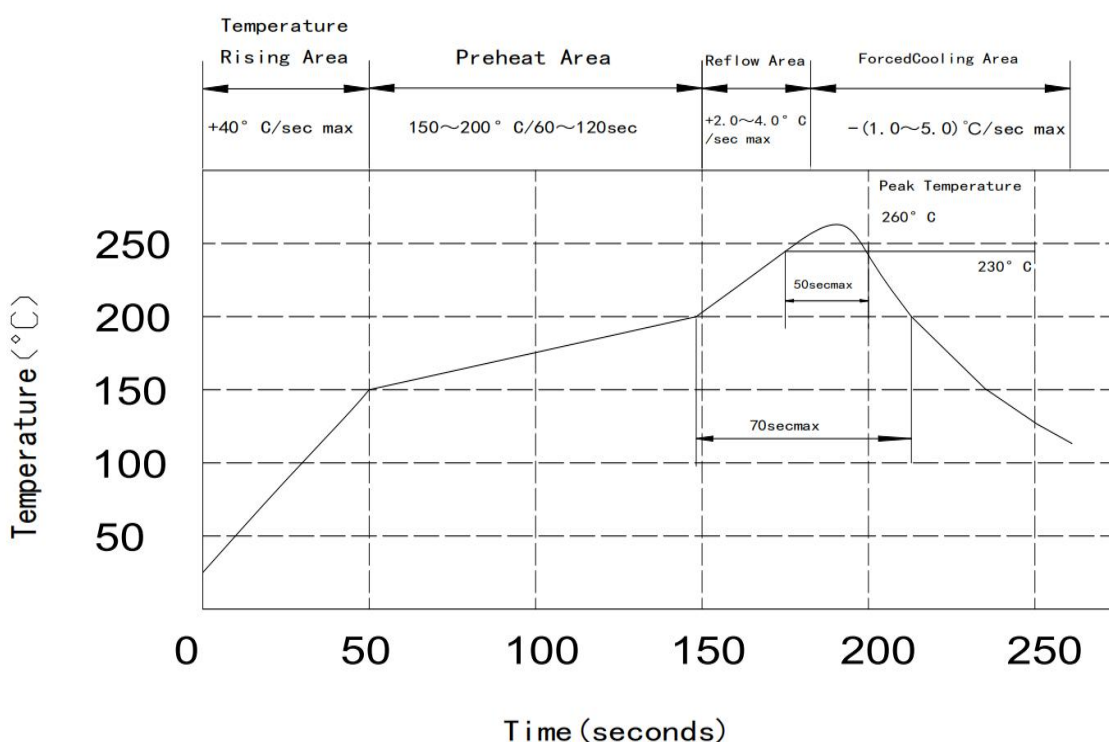
Recommended Soldering Technologies 回流焊建议

Reflowing Profile

Peak Temp: 260°C max.

Max time above 230°C : 50sec max.

Max time above 200°C : 70sec max



Safety Reminders 注意事项

SAFETY REMINDERS

- The storage period is within 12 months. Be sure to follow the storage conditions (temperature: 15 to 35°C, humidity: 75% RH or less). If the storage period elapses, the soldering of the terminal electrodes may deteriorate.
- Do not use or store in locations where there are conditions such as gas corrosion (salt, acid, alkali, etc.).
- Soldering corrections after mounting should be within the range of the conditions determined in the specifications. If overheated, a short circuit, performance deterioration, or lifespan shortening may occur.
- When embedding a printed circuit board where a chip is mounted to a set, be sure that residual stress is not given to the chip due to the overall distortion of the printed circuit board and partial distortion such as at screw tightening portions.
- Self heating (temperature increase) occurs when the power is turned ON, so the tolerance should be sufficient for the set thermal design.
- This product is not designed for production processes involving ultrasonic welding, as high-frequency vibration may cause application issues such as product detachment and breakage.
- Carefully layout the coil for the circuit board design of the non-magnetic shield type. A malfunction may occur due to magnetic interference.
- Use a wrist band to discharge static electricity in your body through the grounding wire.
- Do not expose the products to magnets or magnetic fields.
- Do not use for a purpose outside of the contents regulated in the delivery specifications.
- The products listed on this catalog are intended for use in general electronic equipment, under a normal operation and use condition.

All products listed in this specification are developed, designed and intended for use in general electronics equipment. The products are not designed or Warranted to meet the requirements of the applications listed below, whose performance and/or quality require especially high reliability, or whose failure, malfunction or trouble might directly cause damage to society, person, or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below. Please contact us for more details if you intend to use our products in the following applications.

- (1) Aerospace/aviation equipment
- (2) Transportation equipment (cars, electric trains, ships, etc.)
- (3) Medical equipment
- (4) Power-generation control equipment
- (5) Atomic energy-related equipment
- (6) Seabed equipment
- (7) Transportation control equipment
- (8) Public information-processing equipment
- (9) Military equipment
- (10) Electric heating apparatus, burning equipment
- (11) Disaster prevention/crime prevention equipment
- (12) Safety equipment
- (13) Other applications that are not considered general-purpose applications

When designing your equipment even for general-purpose applications, you are kindly requested to take into consideration securing protection circuit/device or providing backup circuits in your equipment.